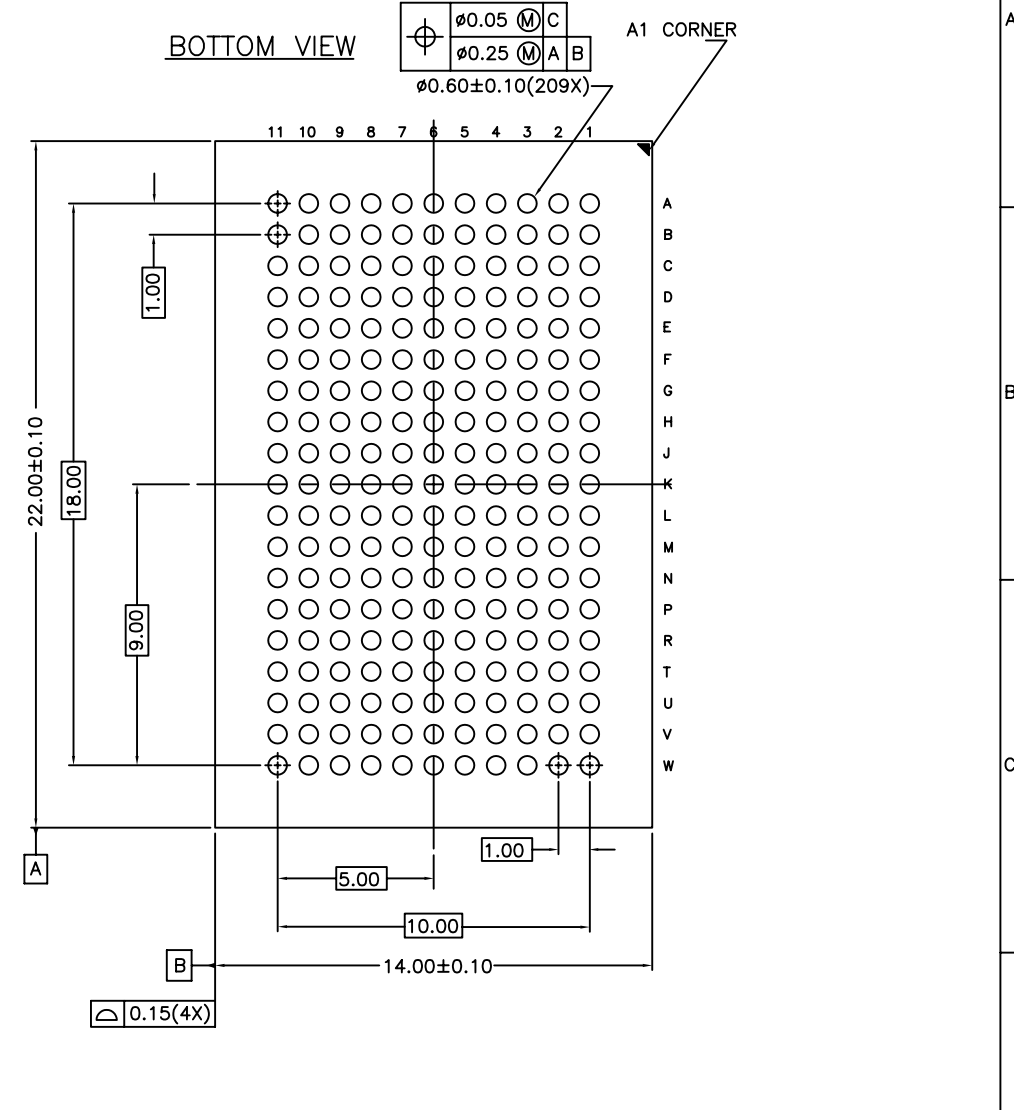
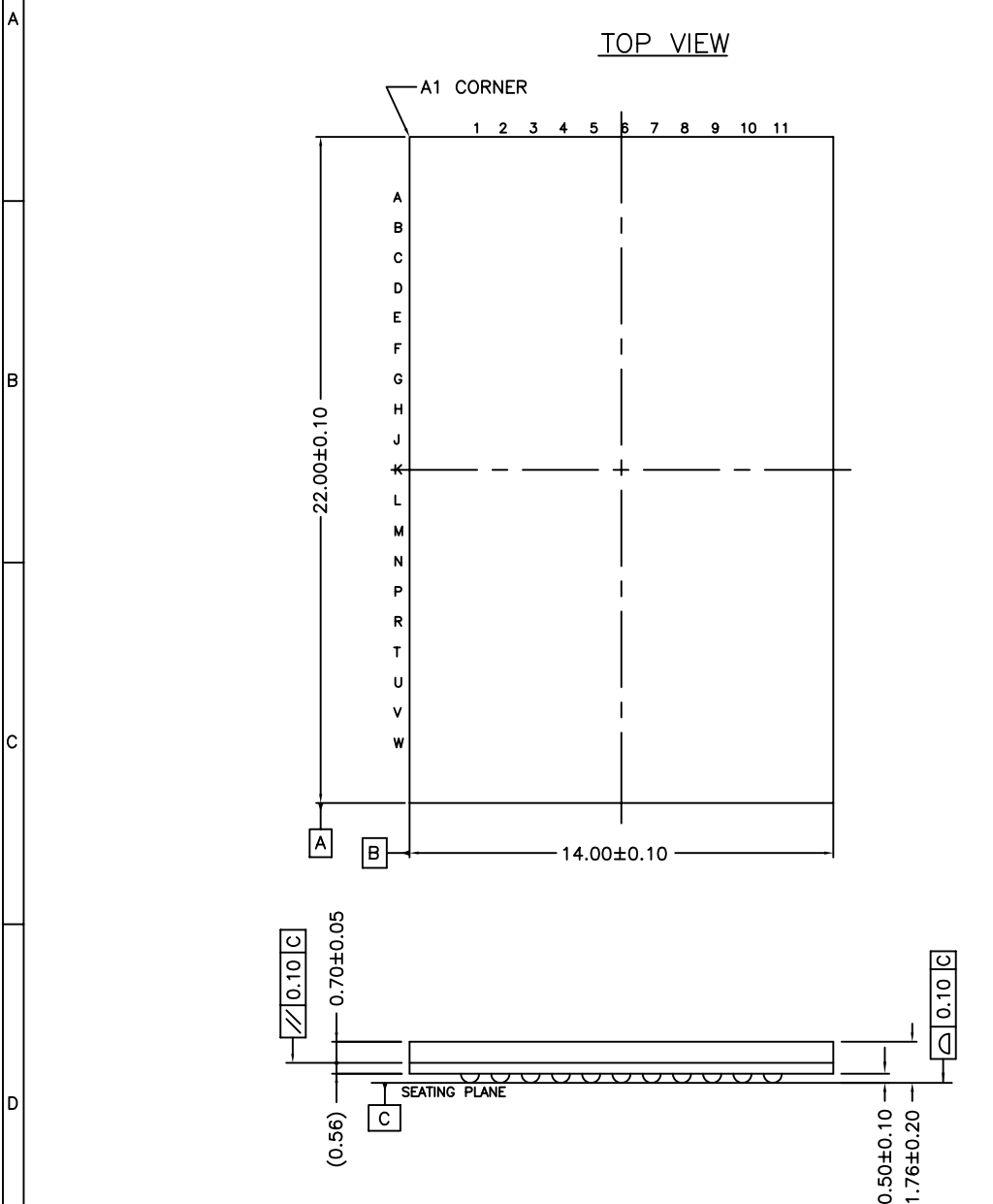


REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	-	**	116778	NEW RELEASE	06/21/02	N/A
1	-	*A	2811684	Changed Template & Title from 209 FBGA 14 X 22 X 1.76MM PKG. OUTL. to PACKAGE OUTLINE, 209L FBGA 14X22X1.76 MM BB209A.	11/19/09	QAD



UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE IN MILLIMETERS STANDARD TOLERANCES ARE: DECIMALS .XX ± 0.05 .XXX ± .XXXX + ANGLES ± 1°	DESIGNED BY HTN	DATE 06/21/02					
	DRAWN BY HTN	DATE 06/21/02					
	CHECKED BY TSV	DATE 11/19/09					
	APPROVED BY QAD	DATE 11/19/09					
MATERIAL N/A	APPROVED BY JGUA	DATE 11/19/09	TITLE PACKAGE OUTLINE, 209L FBGA 14X22X1.76 MM BB209A				
FINISH N/A	APPROVED BY CMG	DATE 11/19/09	<table border="1"> <tr> <td>SIZE A</td> <td>PART NO. BB209A</td> <td>DWG NO. 51-85167</td> <td>REV *A</td> </tr> </table>	SIZE A	PART NO. BB209A	DWG NO. 51-85167	REV *A
SIZE A	PART NO. BB209A	DWG NO. 51-85167	REV *A				

THIS DRAWING CONTAINS INFORMATION WHICH IS THE PROPRIETARY PROPERTY OF CYPRESS SEMICONDUCTOR CORPORATION. THIS DRAWING IS RECEIVED IN CONFIDENCE AND ITS CONTENTS MAY NOT BE DISCLOSED WITHOUT WRITTEN CONSENT OF CYPRESS SEMICONDUCTOR CORPORATION.

SCALE TO FIT	N/A	SHEET 1 OF 1
--------------	-----	--------------